

Sub B1 cont'd
AC
5 (Amended) A molding material for use with carbon dioxide refrigerant according to Claim 1, wherein 1-10 parts by weight of an organic peroxide is further contained on the basis of 100 parts by weight of the chlorinated polyethylene or its blend with the vinyl chloride-based resin.

6. (Amended) A molding material for use with carbon dioxide refrigerant according to Claim 1, for use as a molding material for sealing materials in carbon dioxide refrigerant-contacting apparatuses.

Please add new claim 7 as follows:

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A7
- 7. A molding material for use with carbon dioxide refrigerant according to Claim 2, wherein a vinyl, epoxy or methacryloxy silane coupling agent is further contained.- -

Please add new claim 8 as follows:

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A8
- 8. A molding material for use with carbon dioxide refrigerant according to Claim 2, wherein an inorganic filler is further contained.- -

Please add new claim 9 as follows:

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A9
- 9. A molding material for use with carbon dioxide refrigerant according to Claim 2, wherein 1-10 parts by weight of an organic peroxide is further contained on the basis of 100 parts by weight of the chlorinated polyethylene or its blend with the vinyl chloride-based resin.- -

Please add new claim 10 as follows:

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A10
- 10. A molding material for use with carbon dioxide refrigerant according to Claim 4, wherein 1-10 parts by weight of an organic peroxide is further contained on the basis of 100 parts by weight of the chlorinated polyethylene or its blend with the vinyl chloride-based resin.- -

Please add new claim 11 as follows:

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A11
- 11. A molding material for use with carbon dioxide refrigerant according to Claim 2, for use as a molding material for sealing materials in carbon dioxide refrigerant-contacting apparatuses.- -